Dual non-inverting Schmitt trigger

Rev. 1 — 16 May 2013

Product data sheet

1. General description

The 74HC3G34-Q100; 74HCT3G34-Q100 are triple buffers. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels:
 - ◆ For 74HC3G34-Q100: CMOS level
 - For 74HCT3G34-Q100: TTL level
- Wide supply voltage range from 2.0 V to 6.0 V
- Symmetrical output impedance
- High noise immunity
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Low-power dissipation
- Balanced propagation delays
- Multiple package options

3. Ordering information

Table 1.Ordering information

Type number	Package	'ackage								
	Temperature range	Name	Description	Version						
74HC3G34DP-Q100	–40 °C to +125 °C	TSSOP8								
74HCT3G34DP-Q100			body width 3 mm; lead length 0.5 mm							
74HC3G34DC-Q100	–40 °C to +125 °C	VSSOP8	F	SOT765-1						
74HCT3G34DC-Q100	-		body width 2.3 mm							



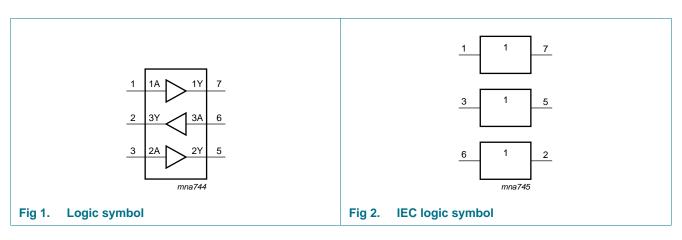
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4. Marking

Table 2. Marking	
Type number	Marking code ^[1]
74HC3G34DP-Q100	H34
74HCT3G34DP-Q100	T34
74HC3G34DC-Q100	P34
74HCT3G34DC-Q100	U34

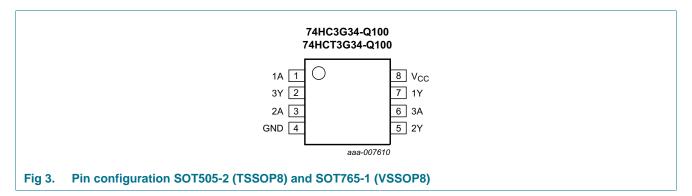
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1 Pinning



74HC_HCT3G34_Q100

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6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
1A, 2A, 3A	1, 3, 6	data input
1Y, 2Y, 3Y	7, 5, 2	data output
GND	4	ground (0 V)
V _{CC}	8	supply voltage

7. Functional description

Table 4. Function table [1]	
Input	Output
nA	nY
L	L
Н	Н

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	V_{O} = -0.5 V to (V _{CC} + 0.5 V)	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[2] _	300	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 package: above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K. For VSSOP8 package: above 110 °C the value of P_{tot} derates linearly with 8 mW/K.

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9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol Parameter		Conditions	74H	C3G34-0	2100	74H0	CT3G34-	Q100	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
	and fall rate	$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 7.Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C t	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
74HC3G3	4-Q100							
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	V
		$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	V
V _{IL}	LOW-level input	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	V
	voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	V
V _{OH} H	HIGH-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	V
		I_{O} = -4.0 mA; V_{CC} = 4.5 V	4.13	4.32	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.63	5.81	-	5.2	-	V
V _{OL}	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±1.0	-	±1.0	μΑ
СС	supply current	per input pin; $V_I = V_{CC}$ or GND; $I_O = 0 \text{ A}$; $V_{CC} = 6.0 \text{ V}$	-	-	10	-	20	μΑ
C _I	input capacitance		-	1.5	-	-	-	pF

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Symbol Parameter Conditions		Conditions	–40 °C to +85 °C			_40 °C t	o +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
74HCT3G	34-Q100				I			
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	V
V _{OH}	HIGH-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	V
		I_{O} = -4.0 mA; V_{CC} = 4.5 V	4.13	4.32	-	3.7	-	V
V _{OL}	LOW-level output	$V_I = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.33	-	0.4	V
li	input leakage current	V_{I} = V_{CC} or GND; V_{CC} = 5.5 V	-	-	±1.0	-	±1.0	μA
lcc	supply current	$V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A};$ $V_{CC} = 5.5 \text{ V}$	-	-	10	-	20	μΑ
ΔI _{CC}	additional supply current	per input; V _{CC} = 4.5 V to 5.5 V; V _I = V _{CC} - 2.1 V; I _O = 0 A	-	-	375	-	410	μΑ
CI	input capacitance		-	1.5	-	-	-	pF

Table 7.Static characteristics ... continuedVoltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 5</u>.

Symbol	Parameter	Conditions		-40	–40 °C to +85 °C			–40 °C to +125 °C	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
74HC3G	34-Q100								
t _{pd}	propagation delay	nA to nY; see Figure 4	[2]						
		$V_{CC} = 2.0 V$		-	29	95	-	125	ns
		$V_{CC} = 4.5 V$		-	9	19	-	25	ns
		$V_{CC} = 6.0 V$		-	8	16	-	20	ns
tt	transition time	nY; see Figure 4	<u>[3]</u>						
		$V_{CC} = 2.0 V$		-	18	95	-	125	ns
		$V_{CC} = 4.5 V$		-	6	19	-	25	ns
		$V_{CC} = 6.0 V$		-	5	16	-	20	ns
C_{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC}	<u>[4]</u>	-	10	-	-	-	pF

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Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C t	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
74HCT30	G34-Q100								
t _{pd}	propagation delay	nA to nY; see Figure 4	[2]						
		$V_{CC} = 4.5 V$		-	10	23	-	29	ns
tt	transition time	nY; V_{CC} = 4.5 V; see Figure 4	[3]	-	6	19	-	25	ns
C _{PD}	power dissipation capacitance	V_{I} = GND to V_{CC} – 1.5 V	<u>[4]</u>	-	9	-	-	-	pF

Table 8. Dynamic characteristics ... continued

[1] All typical values are measured at $T_{amb} = 25 \text{ °C}$.

[2] t_{pd} is the same as t_{PLH} and t_{PHL}.

[3] t_t is the same as t_{TLH} and t_{THL} .

 C_{PD} is used to determine the dynamic power dissipation (P_D in μW). [4]

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of outputs.

12. Waveforms

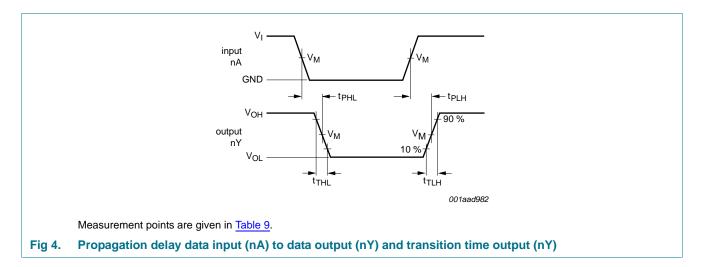


Table 9. **Measurement points**

Туре	Input	Output
	V _M	V _M
74HC3G34-Q100	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
74HCT3G34-Q100	1.3 V	1.3 V

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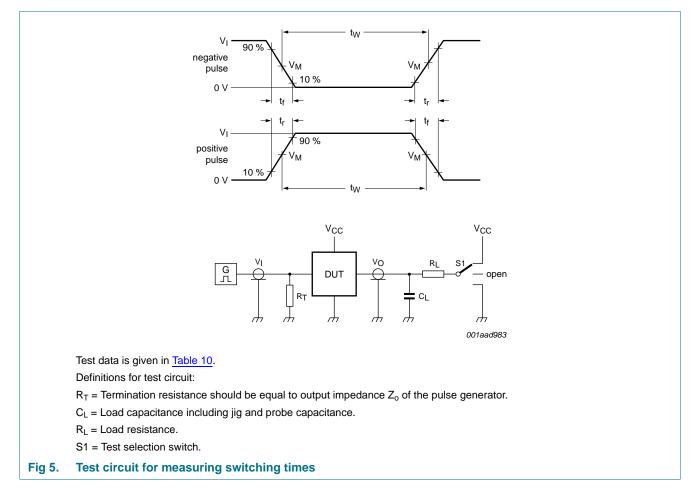


Table 10. Test data

Туре	Input		Load		S1 position
	VI	t _r , t _f	CL	R _L	t _{PHL} , t _{PLH}
74HC3G34-Q100	GND to V _{CC}	≤ 6 ns	50 pF	1 kΩ	open
74HCT3G34-Q100	GND to 3 V	\leq 6 ns	50 pF	1 kΩ	open

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13. Package outline

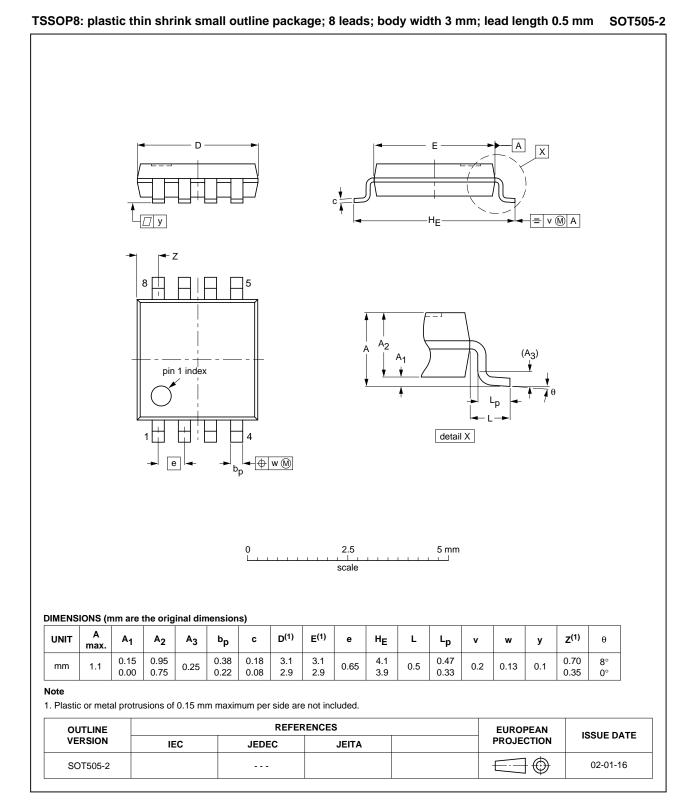


Fig 6. Package outline SOT505-2 (TSSOP8)

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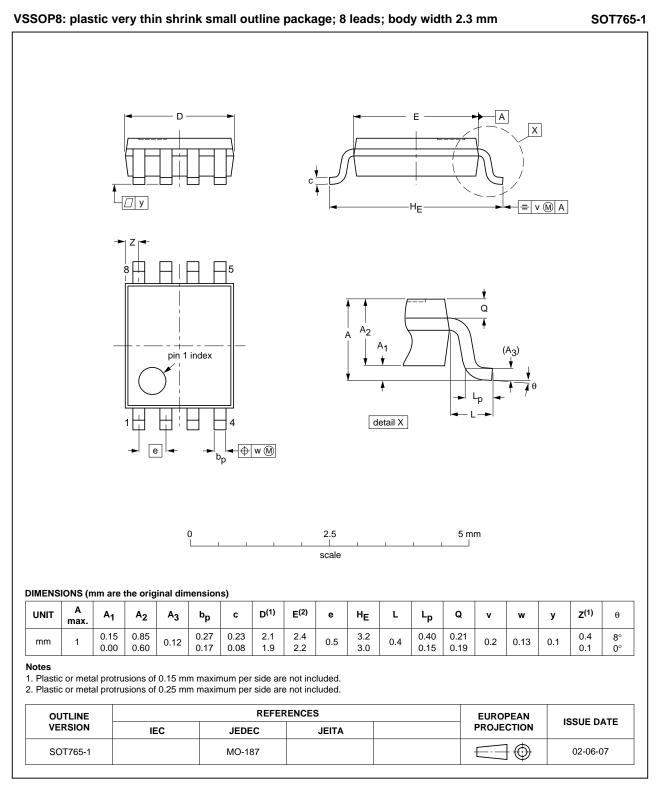


Fig 7. Package outline SOT765-1 (VSSOP8)

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14. Abbreviations

Table 11. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

15. Revision history

Table 12. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT3G34_Q100 v.1	20130516	Product data sheet	-	-			

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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